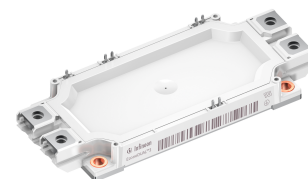


Final datasheet

Features

- Electrical features
 - $V_{CES} = 1200\text{ V}$
 - $I_{C\text{ nom}} = 150\text{ A} / I_{CRM} = 300\text{ A}$
 - Suitable Infineon gate drivers can be found under <https://www.infineon.com/gdfinder>
 - Integrated temperature sensor
- Mechanical features
 - Standard housing
 - Solder contact technology
 - Isolated base plate
 - High power density



Potential applications

- Industrial drives
- Energy storage systems

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

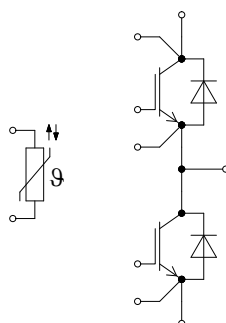


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1 Package

1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, $f = 50 \text{ Hz}$, $t = 1 \text{ min}$	2.5	kV
Isolation test voltage NTC	$V_{ISOL(NTC)}$	RMS, $f = 50 \text{ Hz}$, $t = 1 \text{ min}$	2.5	kV
Material of module baseplate			Cu	
Internal isolation		basic insulation (class 1, IEC 61140)	Al_2O_3	
Creepage distance	$d_{\text{Creep nom}}$	terminal to baseplate, nom.	> 15	mm
Creepage distance	$d_{\text{Creep min}}$	terminal to baseplate, min.	14.7	mm
Creepage distance	$d_{\text{Creep nom}}$	terminal to terminal, nom.	> 19.3	mm
Creepage distance	$d_{\text{Creep min}}$	terminal to terminal, min.	19.3	mm
Clearance	$d_{\text{Clear nom}}$	terminal to baseplate, nom.	> 12.5	mm
Clearance	$d_{\text{Clear min}}$	terminal to baseplate, min.	12.5	mm
Clearance	$d_{\text{Clear nom}}$	terminal to terminal, nom.	> 10	mm
Clearance	$d_{\text{Clear min}}$	terminal to terminal, min.	9.6	mm
Comparative tracking index	CTI		> 225	
Relative thermal index (electrical)	RTI	housing	140	°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Thermal resistance, case to heat sink	R_{thCH}	$\lambda_{\text{grease}} = 1 \text{ W/(m}\cdot\text{K)}$		0.009		K/W
Stray inductance module	L_{SCE}			20		nH
Module lead resistance, terminals - chip	$R_{\text{CC'+EE'}}$	$T_C = 25 \text{ °C}$, per switch		1.1		mΩ
Storage temperature	T_{stg}		-40		125	°C
Mounting torque for module mounting	M	- Mounting according to valid application note	3		6	Nm
Terminal connection torque	M	- Mounting according to valid application note	3		6	Nm
Weight	G			340		g

2 IGBT, Inverter

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CES}		$T_{vj} = 25\text{ °C}$	1200	V
Continuous DC collector current	I_{CDC}	$T_{vj\text{ max}} = 150\text{ °C}$	$T_C = 75\text{ °C}$	150	A
Repetitive peak collector current	I_{CRM}	t_p limited by $T_{vj\text{ op}}$		300	A
Gate-emitter peak voltage	V_{GES}			± 20	V

Table 4 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\text{ sat}}$	$I_C = 150\text{ A}$, $V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ °C}$		3.20	3.70	V
			$T_{vj} = 125\text{ °C}$		3.85		
Gate threshold voltage	V_{GEth}	$I_C = 6\text{ mA}$, $V_{CE} = V_{GE}$, $T_{vj} = 25\text{ °C}$		4.50	5.50	6.50	V
Gate charge	Q_G	$V_{GE} = \pm 15\text{ V}$, $T_{vj} = 25\text{ °C}$			1.6		μC
Internal gate resistor	R_{Gint}	$T_{vj} = 25\text{ °C}$			1.7		Ω
Input capacitance	C_{ies}	$f = 1000\text{ kHz}$, $T_{vj} = 25\text{ °C}$, $V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$			11		nF
Reverse transfer capacitance	C_{res}	$f = 1000\text{ kHz}$, $T_{vj} = 25\text{ °C}$, $V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$			0.5		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 1200\text{ V}$, $V_{GE} = 0\text{ V}$	$T_{vj} = 25\text{ °C}$			5	mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\text{ V}$, $V_{GE} = 20\text{ V}$, $T_{vj} = 25\text{ °C}$				400	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 150\text{ A}$, $V_{CC} = 600\text{ V}$, $V_{GE} = \pm 15\text{ V}$, $R_{Gon} = 7.5\text{ }\Omega$	$T_{vj} = 25\text{ °C}$		0.100		μs
			$T_{vj} = 125\text{ °C}$		0.110		
Rise time (inductive load)	t_r	$I_C = 150\text{ A}$, $V_{CC} = 600\text{ V}$, $V_{GE} = \pm 15\text{ V}$, $R_{Gon} = 7.5\text{ }\Omega$	$T_{vj} = 25\text{ °C}$		0.060		μs
			$T_{vj} = 125\text{ °C}$		0.070		
Turn-off delay time (inductive load)	t_{doff}	$I_C = 150\text{ A}$, $V_{CC} = 600\text{ V}$, $V_{GE} = \pm 15\text{ V}$, $R_{Goff} = 7.5\text{ }\Omega$	$T_{vj} = 25\text{ °C}$		0.530		μs
			$T_{vj} = 125\text{ °C}$		0.550		
Fall time (inductive load)	t_f	$I_C = 150\text{ A}$, $V_{CC} = 600\text{ V}$, $V_{GE} = \pm 15\text{ V}$, $R_{Goff} = 7.5\text{ }\Omega$	$T_{vj} = 25\text{ °C}$		0.030		μs
			$T_{vj} = 125\text{ °C}$		0.040		
Turn-on energy loss per pulse	E_{on}	$I_C = 150\text{ A}$, $V_{CC} = 600\text{ V}$, $L_\sigma = 80\text{ nH}$, $V_{GE} = \pm 15\text{ V}$, $R_{Gon} = 7.5\text{ }\Omega$, $di/dt = 2700\text{ A}/\mu\text{s}$ ($T_{vj} = 125\text{ °C}$)	$T_{vj} = 25\text{ °C}$		9		mJ
			$T_{vj} = 125\text{ °C}$		14.5		

(table continues...)

Table 4 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Turn-off energy loss per pulse	E_{off}	$I_C = 150\text{ A}$, $V_{CC} = 600\text{ V}$, $L_\sigma = 80\text{ nH}$, $V_{GE} = \pm 15\text{ V}$, $R_{Goff} = 7.5\text{ }\Omega$, $dv/dt = 6500\text{ V}/\mu\text{s}$ ($T_{vj} = 125\text{ }^\circ\text{C}$)	$T_{vj} = 25\text{ }^\circ\text{C}$	8		mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$	11		
SC data	I_{SC}	$V_{GE} \leq 15\text{ V}$, $V_{CC} = 900\text{ V}$, $V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$	$t_P \leq 10\text{ }\mu\text{s}$, $T_{vj} = 125\text{ }^\circ\text{C}$	950		A
Thermal resistance, junction to case	R_{thJC}	per IGBT			0.10	K/W
Thermal resistance, case to heat sink	R_{thCH}	per IGBT, $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$		0.03		K/W
Temperature under switching conditions	$T_{vj\text{ op}}$		-40		125	$^\circ\text{C}$

3 Diode, Inverter

Table 5 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Repetitive peak reverse voltage	V_{RRM}		$T_{vj} = 25\text{ }^{\circ}\text{C}$	1200	V
Continuous DC forward current	I_F			150	A
Repetitive peak forward current	I_{FRM}	$t_P = 1\text{ ms}$		300	A
I^2t - value	I^2t	$t_P = 10\text{ ms}$, $V_R = 0\text{ V}$	$T_{vj} = 125\text{ }^{\circ}\text{C}$	5500	A^2s

Table 6 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 150\text{ A}$, $V_{GE} = 0\text{ V}$	$T_{vj} = 25\text{ }^\circ\text{C}$	2.00	2.40	V
			$T_{vj} = 125\text{ }^\circ\text{C}$	1.70		
Peak reverse recovery current	I_{RM}	$V_{CC} = 600\text{ V}$, $I_F = 150\text{ A}$, $V_{GE} = -15\text{ V}$, $-di_F/dt = 2700\text{ A}/\mu\text{s}$ ($T_{vj} = 125\text{ }^\circ\text{C}$)	$T_{vj} = 25\text{ }^\circ\text{C}$	105		A
			$T_{vj} = 125\text{ }^\circ\text{C}$	160		
Recovered charge	Q_r	$V_{CC} = 600\text{ V}$, $I_F = 150\text{ A}$, $V_{GE} = -15\text{ V}$, $-di_F/dt = 2700\text{ A}/\mu\text{s}$ ($T_{vj} = 125\text{ }^\circ\text{C}$)	$T_{vj} = 25\text{ }^\circ\text{C}$	8.7		μC
			$T_{vj} = 125\text{ }^\circ\text{C}$	24		
Reverse recovery energy	E_{rec}	$V_{CC} = 600\text{ V}$, $I_F = 150\text{ A}$, $V_{GE} = -15\text{ V}$, $-di_F/dt = 2700\text{ A}/\mu\text{s}$ ($T_{vj} = 125\text{ }^\circ\text{C}$)	$T_{vj} = 25\text{ }^\circ\text{C}$	3.2		mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$	8.4		

(table continues...)

4 NTC-Thermistor

Table 6 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Thermal resistance, junction to case	R_{thJC}	per diode			0.25	K/W
Thermal resistance, case to heat sink	R_{thCH}	per diode, $\lambda_{grease} = 1 \text{ W/(m}\cdot\text{K)}$		0.05		K/W
Temperature under switching conditions	T_{vjop}		-40		125	°C

4 NTC-Thermistor

Table 7 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	R_{25}	$T_{NTC} = 25 \text{ °C}$		5		kΩ
Deviation of R_{100}	$\Delta R/R$	$T_{NTC} = 100 \text{ °C}$, $R_{100} = 493 \text{ Ω}$	-5		5	%
Power dissipation	P_{25}	$T_{NTC} = 25 \text{ °C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$		3433		K

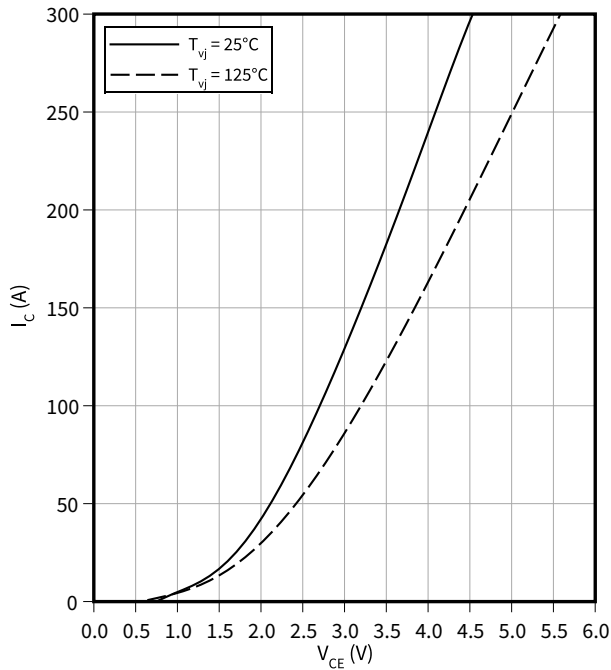
Note: For an analytical description of the NTC characteristics please refer to AN2009-10, chapter 4

5 Characteristics diagrams

Output characteristic (typical), IGBT, Inverter

$I_C = f(V_{CE})$

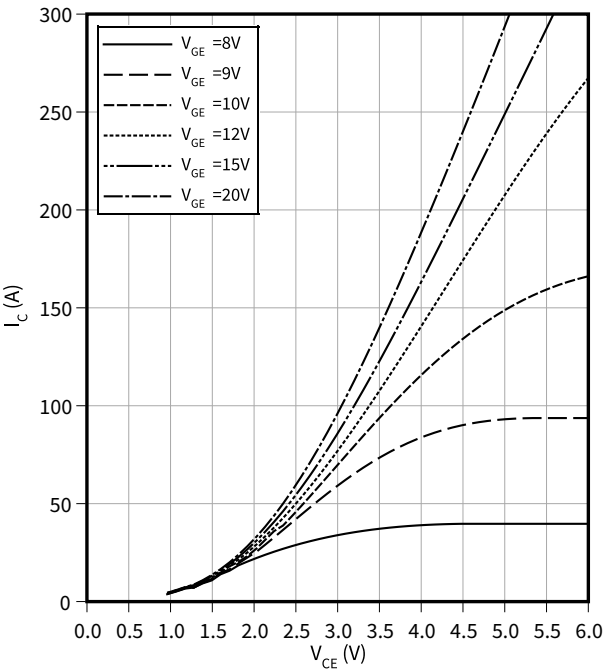
$V_{GE} = 15\text{ V}$



Output characteristic field (typical), IGBT, Inverter

$I_C = f(V_{CE})$

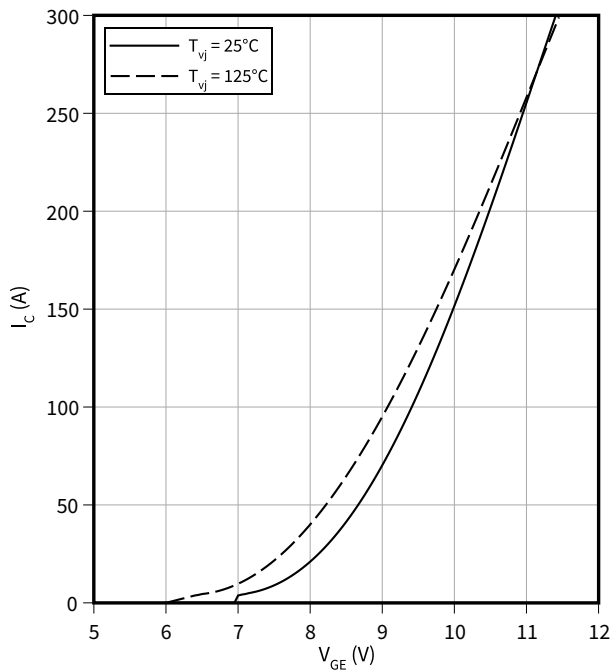
$T_{vj} = 125\text{ °C}$



Transfer characteristic (typical), IGBT, Inverter

$I_C = f(V_{GE})$

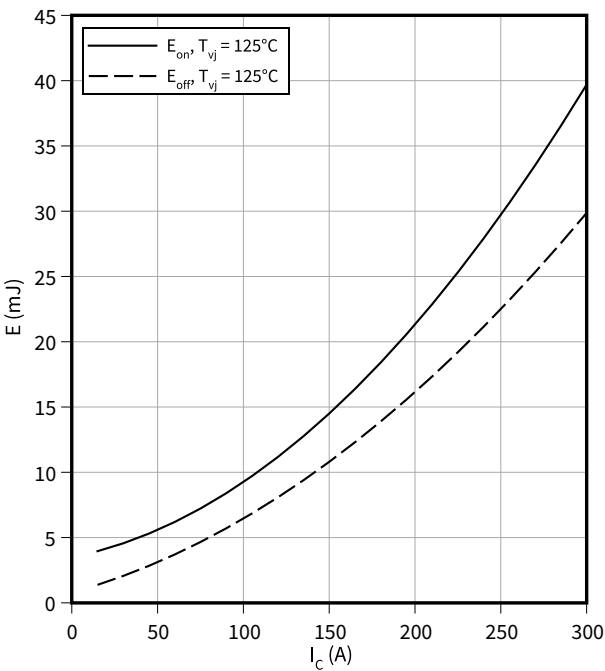
$V_{CE} = 20\text{ V}$



Switching losses (typical), IGBT, Inverter

$E = f(I_C)$

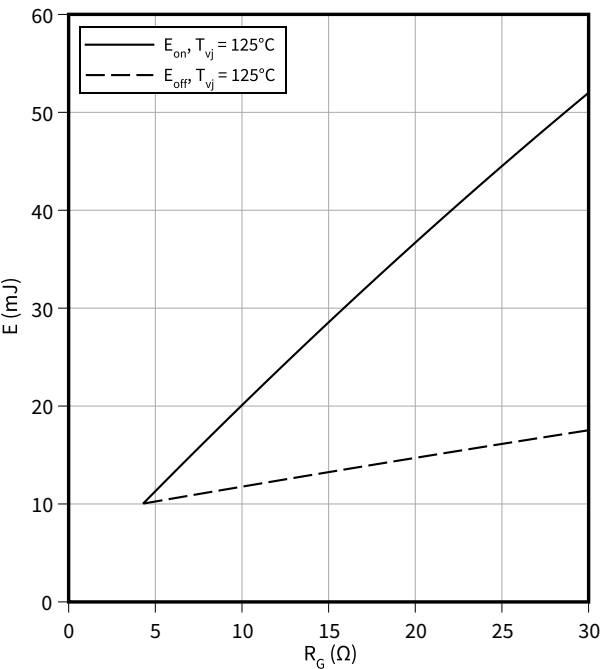
$V_{CC} = 600\text{ V}, R_{Goff} = 7.5\text{ }\Omega, R_{Gon} = 7.5\text{ }\Omega, V_{GE} = \pm 15\text{ V}$



5 Characteristics diagrams

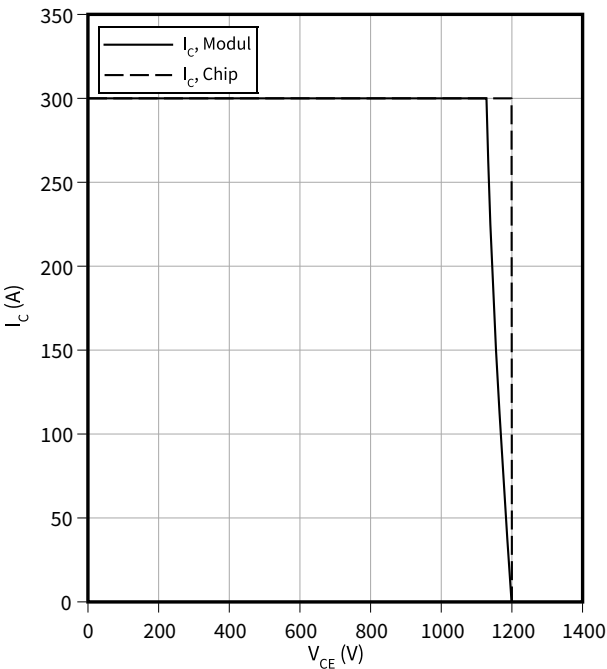
Switching losses (typical), IGBT, Inverter

$E = f(R_G)$
 $V_{GE} = \pm 15\text{ V}$, $I_C = 150\text{ A}$, $V_{CC} = 600\text{ V}$



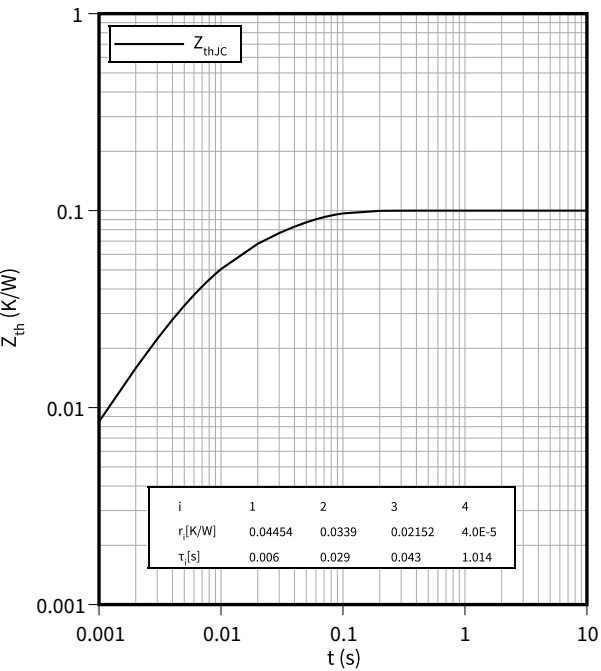
Reverse bias safe operating area (RBSOA), IGBT, Inverter

$I_C = f(V_{CE})$
 $R_{Goff} = 7.5\ \Omega$, $V_{GE} = \pm 15\text{ V}$, $T_{vj} = 125\text{ °C}$



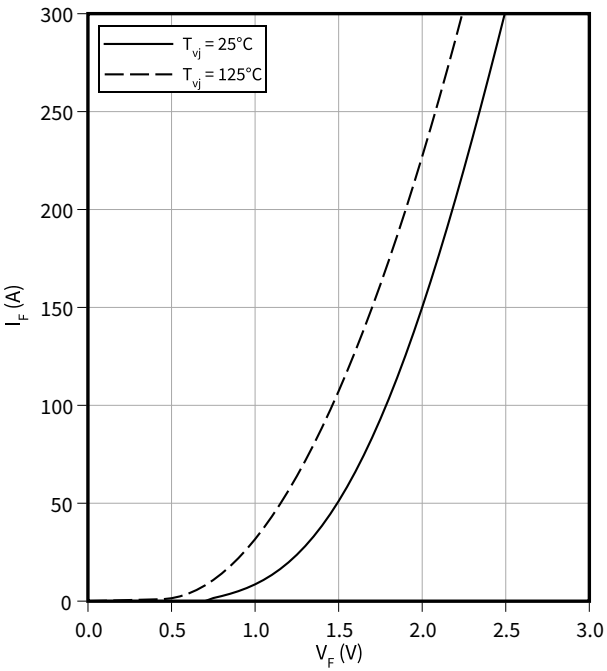
Transient thermal impedance, IGBT, Inverter

$Z_{th} = f(t)$



Forward characteristic (typical), Diode, Inverter

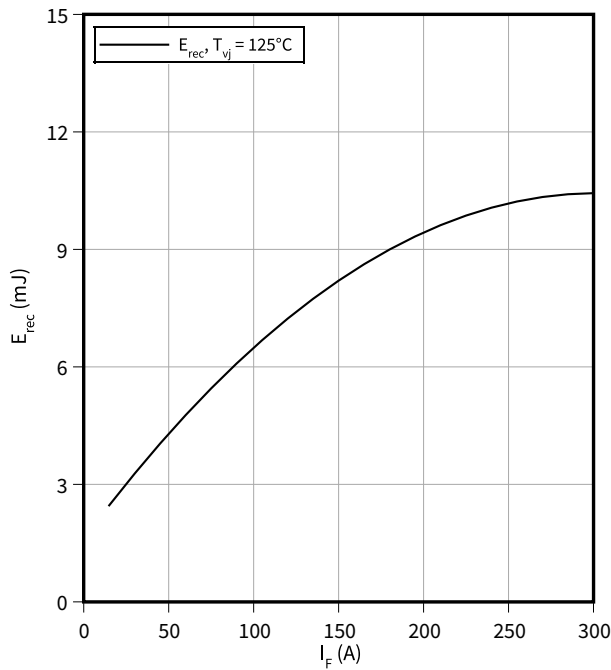
$I_F = f(V_F)$



5 Characteristics diagrams

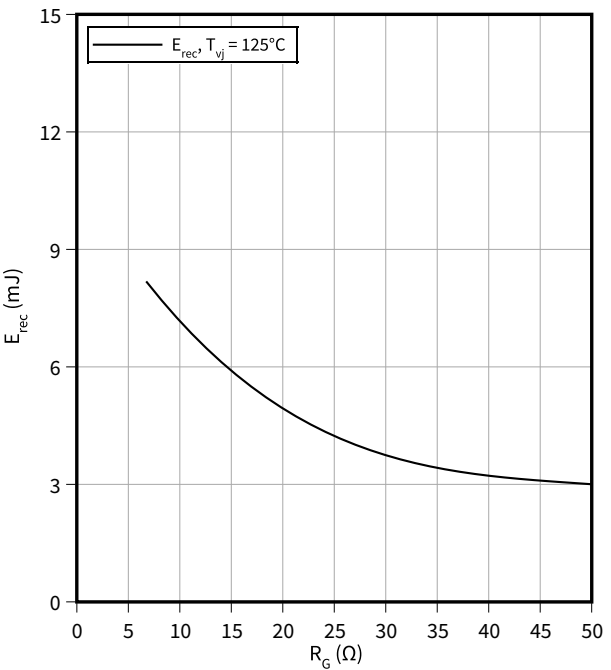
Switching losses (typical), Diode, Inverter

$E_{rec} = f(I_F)$
 $R_{Gon} = 7.5\ \Omega, V_{CE} = 600\ V$



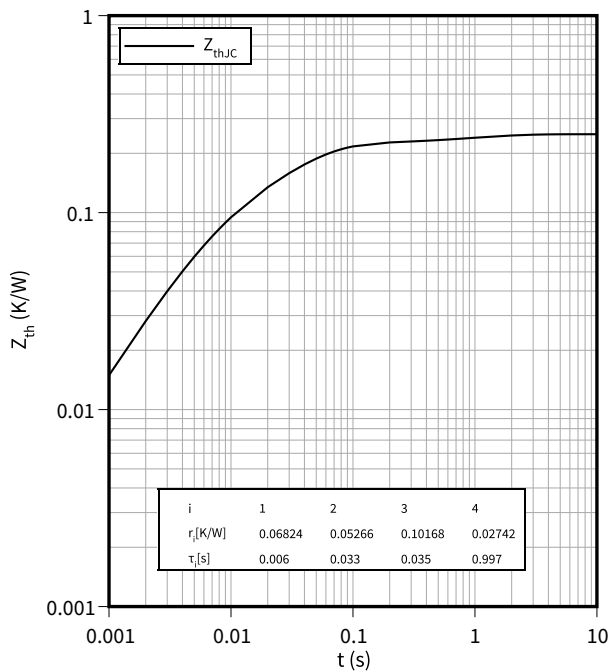
Switching losses (typical), Diode, Inverter

$E_{rec} = f(R_G)$
 $V_{CE} = 600\ V, I_F = 150\ A$



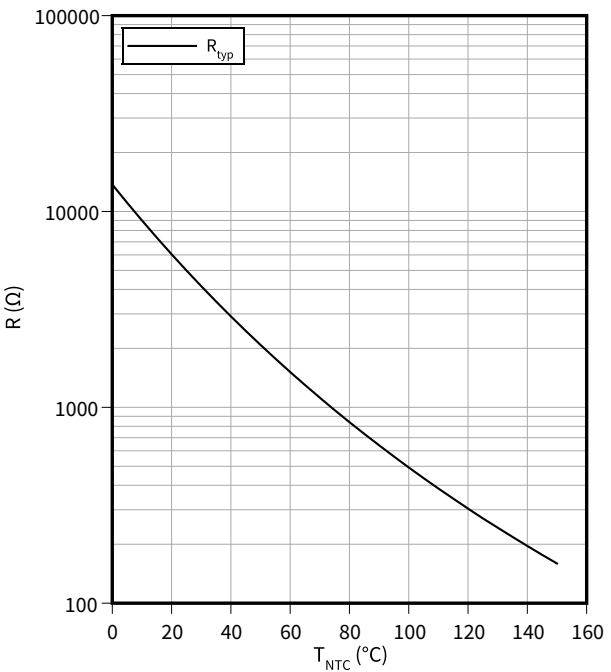
Transient thermal impedance, Diode, Inverter

$Z_{th} = f(t)$



Temperature characteristic (typical), NTC-Thermistor

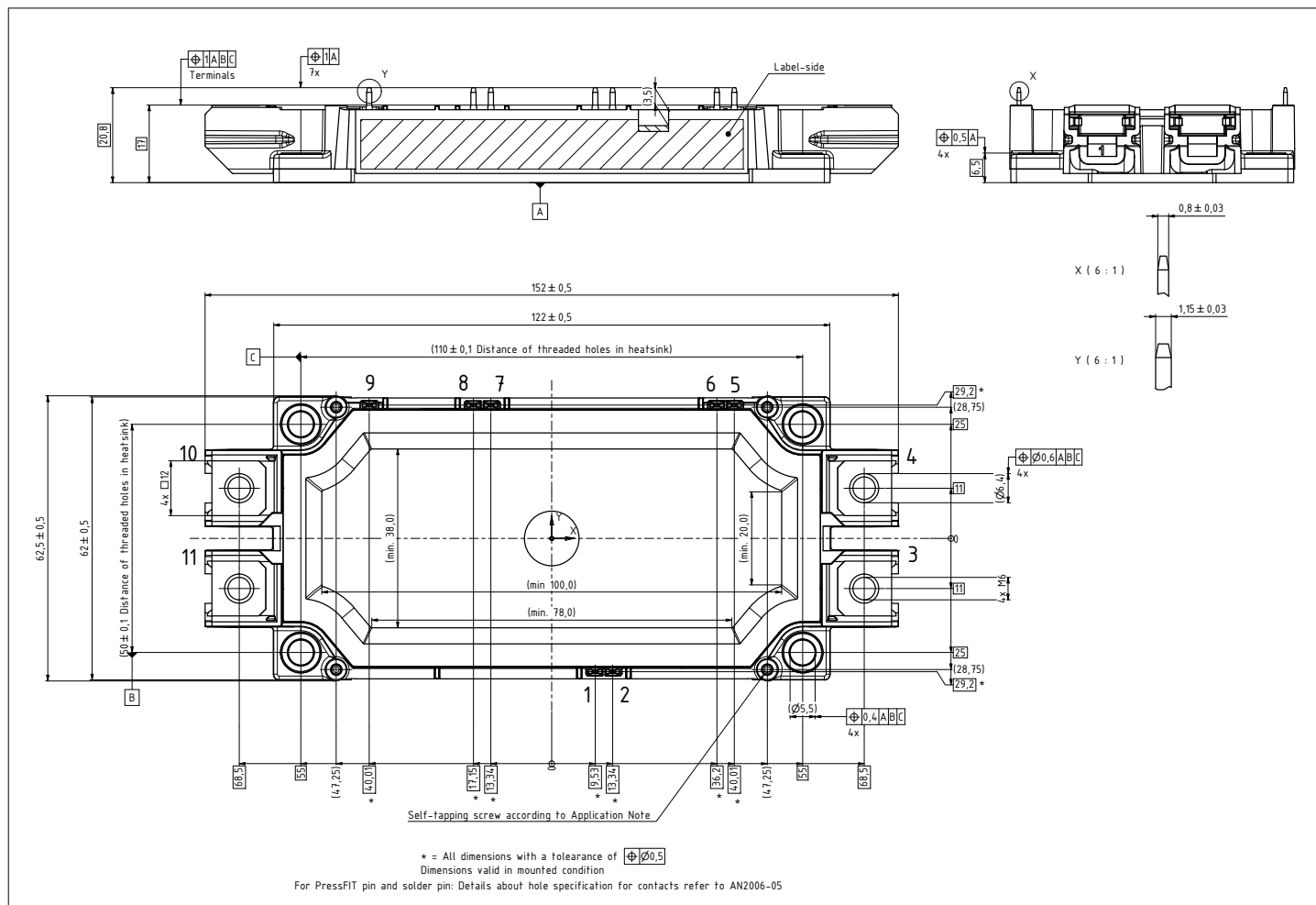
$R = f(T_{NTC})$



6 Circuit diagram



Figure 1



8 Module label code

Module label code			
Code format	Data Matrix		Barcode Code128
Encoding	ASCII text		Code Set A
Symbol size	16x16		23 digits
Standard	IEC24720 and IEC16022		IEC8859-1
Code content	Content	Digit	Example
	Module serial number	1 – 5	71549
	Module material number	6 - 11	142846
	Production order number	12 - 19	55054991
	Date code (production year)	20 – 21	15
	Date code (production week)	22 – 23	30
Example	 7154914284655054991153071549142846550549911530		

Figure 3

Revision history**Revision history**

Document revision	Date of release	Description of changes
V1.0	2005-04-01	Target datasheet
V2.0	2007-06-28	Preliminary datasheet
V2.1	2011-03-01	Preliminary datasheet
n/a	2020-09-01	Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy
1.00	2025-08-06	Final datasheet

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Edition 2025-08-06

Published by

Infineon Technologies AG
81726 Munich, Germany

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Document reference
IFX-AAV068-004

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